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Solid State Relay OCMOS FET PS7241-1C

8-PIN SOP, 400 V BREAK DOWN VOLTAGE TRANSFER TYPE 2-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS7241-1C is a transfer type solid state relay containing normally open (N.O.) contact and normally close (N.C.) contact on output side.

It is suitable for analog signal control because of their low offset and high linearity.

FEATURES

- 2 channel type (1 a + 1 b output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- Low offset voltage
- Ordering number of taping product : PS7241-1C-F3, F4: 1 500 pcs/reel
- <R> Pb-Free product
 - · Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8241/8242
 - CSA approved: No. CA 101391

APPLICATIONS

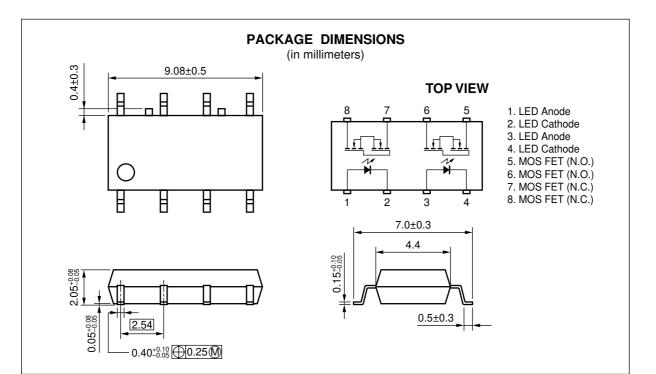
- · Exchange equipment
- Measurement equipment
- FA/OA equipment

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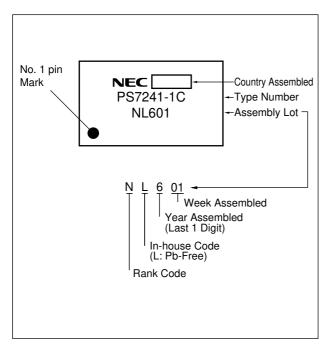
The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS7241-1C	PS7241-1C-A	Pb-Free	Magazine case 45 pcs	Standard products	PS7241-1C
PS7241-1C-F3	PS7241-1C-F3-A		Embossed Tape 1 500 pcs/reel	(UL, BSI, CSA	
PS7241-1C-F4	PS7241-1C-F4-A			approved)	

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lf	50	mA/ch
	Reverse Voltage	VR	5	V
	Power Dissipation	PD	50	mW/ch
	Peak Forward Current 1	I FP	1	A/ch
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	١L	120	mA/ch
	Pulse Load Current ^{*2} (AC/DC Connection)	Ilp	200	mA/ch
	Power Dissipation	PD	180	mW/ch
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		P⊤	460	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-4 shorted together, 5-8 shorted together.

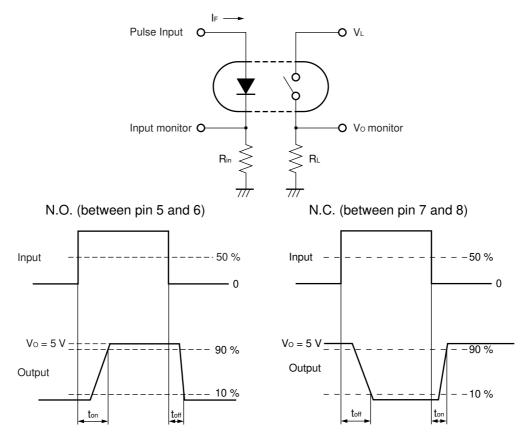
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lf	2	10	20	mA/ch
LED Off Voltage	VF	0		0.5	V

ELECTRICAL	CHARACTERISTICS	(T _A = 25°C)
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	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V _R = 5 V			5	μA
MOS FET	Off-state Leakage Current	Loff	N.O.: $I_F = 0 \text{ mA}, V_D = 400 \text{ V}$		0.03	1.0	μA
			N.C.: IF = 10 mA, VD = 400 V				
	Output Capacitance	Cout	N.O.: V _D = 0 V, f = 1.0 MHz		65		pF/ch
			N.C.: V _D = 0 V, f = 1.0 MHz, I⊧ = 10 mA		185		
Coupled	LED On-state Current	IFon	N.O.: I∟ = 120 mA			2.0	mA
	LED Off-state Current	Foff	N.C.: I∟ = 120 mA				
	On-state Resistance	Ron1	N.O.: I⊧ = 10 mA, I∟ = 10 mA		21	30	Ω
			N.C.: I⊧ = 0 mA, I∟ = 10 mA				
		Ron2	N.O.: IF = 10 mA, IL = 120 mA, t \leq 10 ms		16	25	
			N.C.: IF = 0 mA, IL = 120 mA, t \leq 10 ms				
	Turn-on Time ^{*1, 2}	ton (N.O.)	$I_F=10~mA,~V_0=5~V,~R_L=2~k\Omega,$		0.2	1.0	ms
		ton (N.C.)	$PW \ge 10 ms$		0.02	0.2	
	Turn-off Time *1, 2	toff (N.O.)			0.02	0.2	
		toff (N.C.)			0.1	1.0	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.4		pF/ch

*1 Test Circuit for Switching Time



<R> *2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms. Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

75⁸⁵

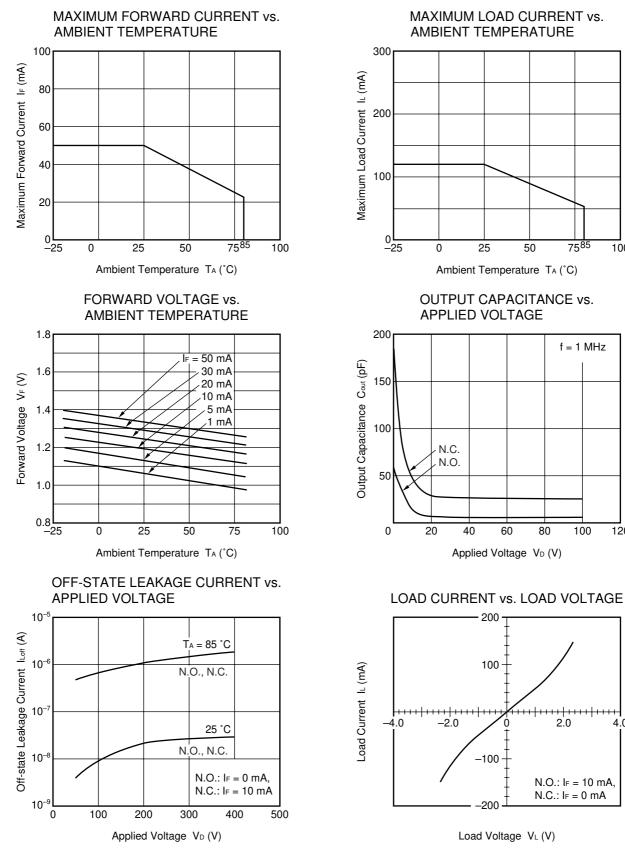
100

120

4.0

100

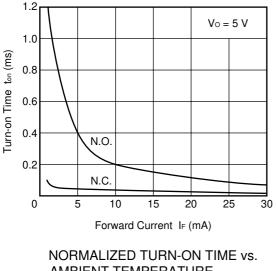
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



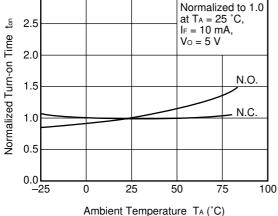


Data Sheet PN10303EJ02V0DS

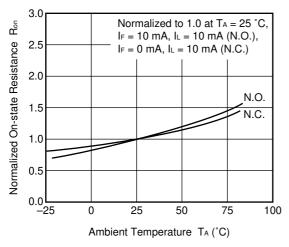






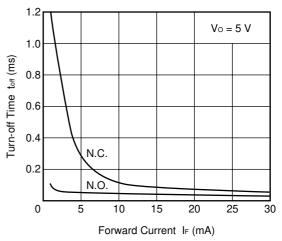


NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE

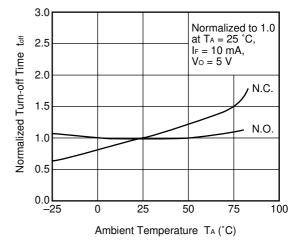


Remark The graphs indicate nominal characteristics.

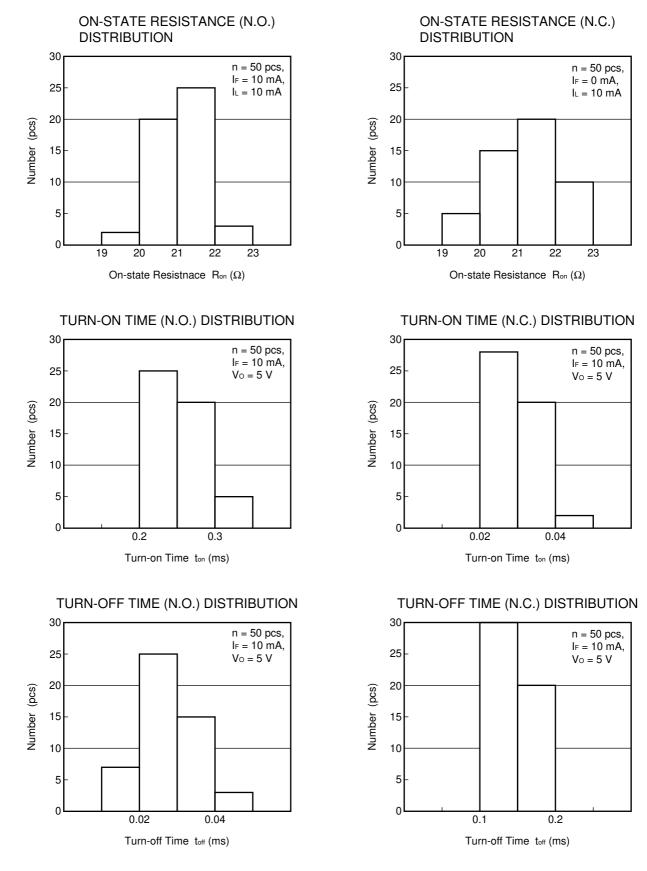
TURN-OFF TIME vs. FORWARD CURRENT



NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE

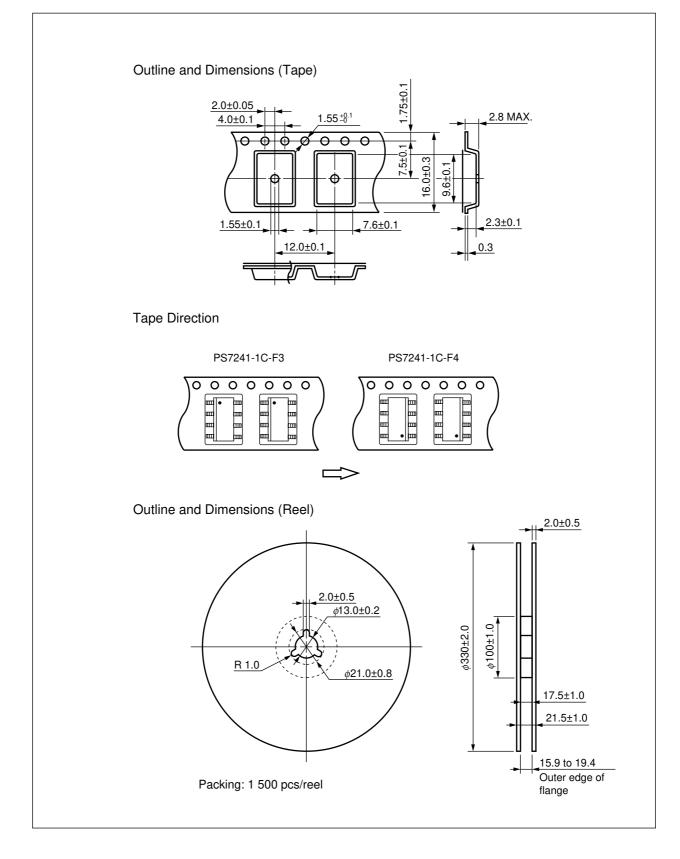


Data Sheet PN10303EJ02V0DS



Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)



RECOMMENDED SOLDERING CONDITIONS

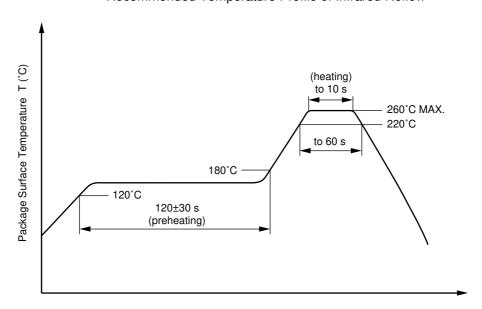
(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 	260°C or below (molten solder temperature)
---------------------------------	--

- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

350°C or below
3 seconds or less
Rosin flux containing small amount of chlorine (The flux with a
maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.

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